

DUAL SURFACE-MOUNT FAST SWITCHING DIODE

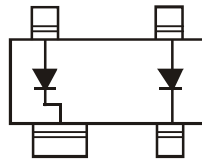
Features

- Fast Switching Speed
- For General Purpose Switching Applications
- Two Electrically Isolated Elements in a Single Compact Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.**
<https://www.diodes.com/quality/product-definitions/>
- An automotive-compliant part is available under a separate datasheet ([BAS28Q](#))

Mechanical Data

- Package: SOT143
- Package Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Alloy 42 Leadframe.
Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram Below
- Weight: 0.009 grams (Approximate)

SOT143



Device Schematic

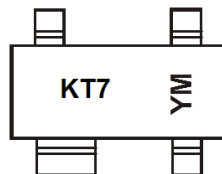
Ordering Information (Note 4)

Orderable Part Number	Package	Packing	
		Qty.	Carrier
BAS28-7	SOT143	3,000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

SOT143



KT7 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: N = 2026)
 M = Month (ex: 9 = September)
 A Bar around the Date Code Marking Denotes Assembly Site

Date Code Key

Year	2015	-	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	C	-	N	P	R	S	T	U	V	W	X	Y

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	85	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	60	V
Forward Current (Note 5)	I _F	215	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	4.0	A
		1.0	
		0.5	
Repetitive Peak Forward Current (Note 5)	I _{FRM}	500	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	85	—	V	I _R = 100μA
Forward Voltage	V _F	—	0.715	V	I _F = 1.0mA
			0.855		I _F = 10mA
			1.0		I _F = 50mA
			1.25		I _F = 150mA
Reverse Current (Note 6)	I _R	—	1.0	μA	V _R = 75V
			50	μA	V _R = 75V, T _J = +150°C
			30	μA	V _R = 25V, T _J = +150°C
			30	nA	V _R = 25V
Total Capacitance	C _T	—	1.5	pF	V _R = 0, f = 1.0MHz
Reverse-Recovery Time	t _{RR}	—	4	ns	I _F = I _R = 10mA, I _{RR} = 0.1 x I _R , R _L = 100Ω

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
6. Short duration pulse test used to minimize self-heating effect.

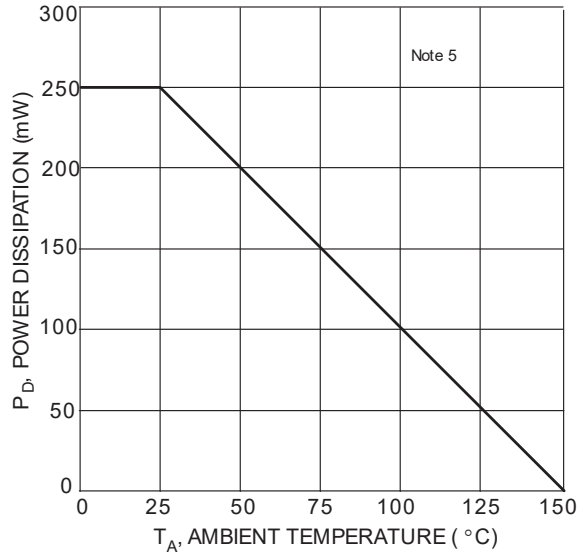


Figure 1 Power Derating Curve, Total Package

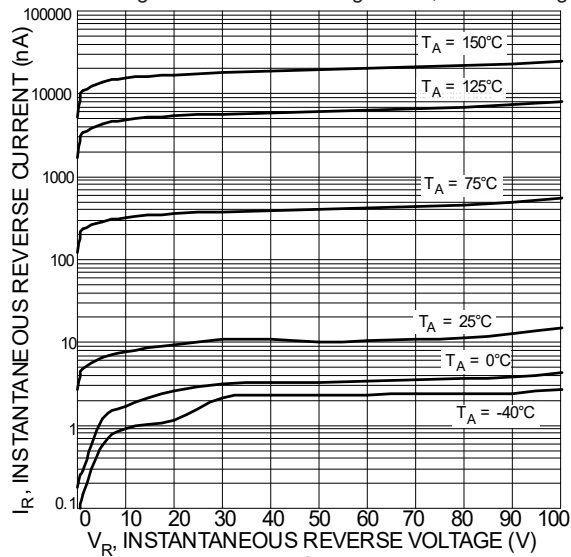


Figure 3 Typical Reverse Characteristics, Per Element

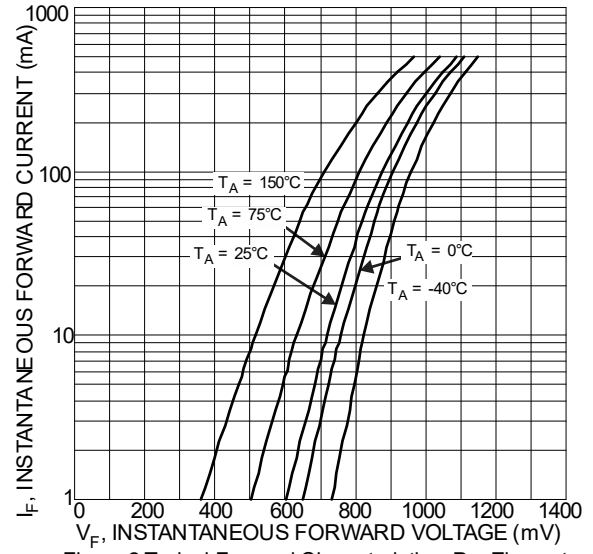


Figure 2 Typical Forward Characteristics, Per Element

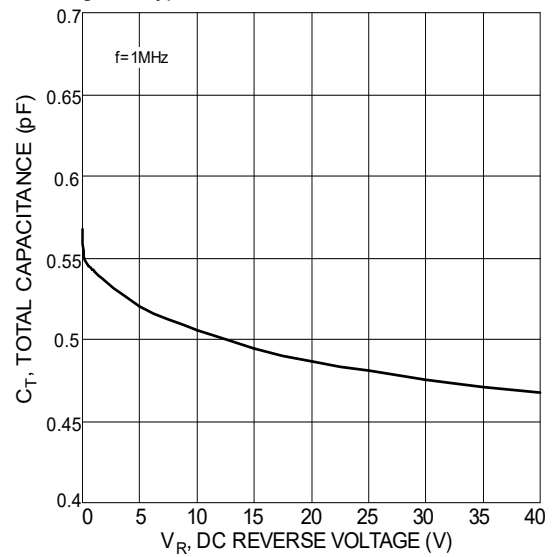
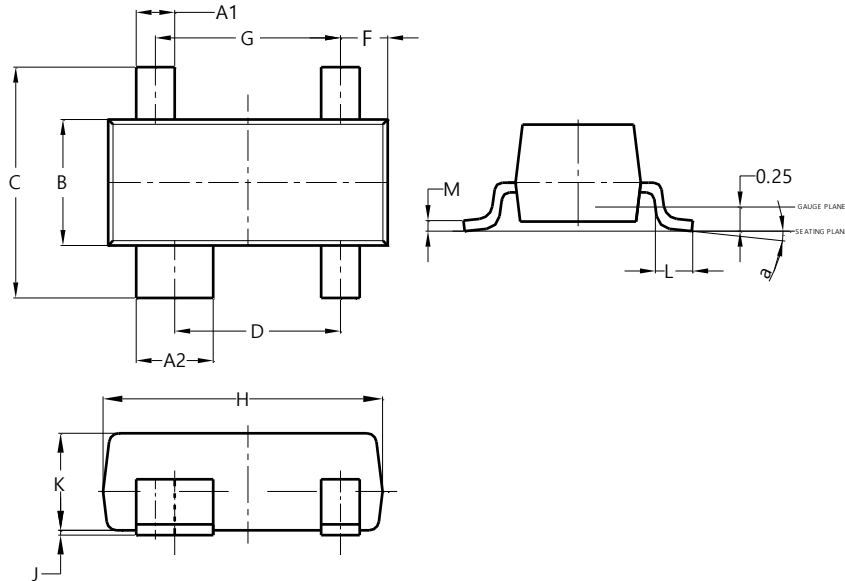


Figure 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT143

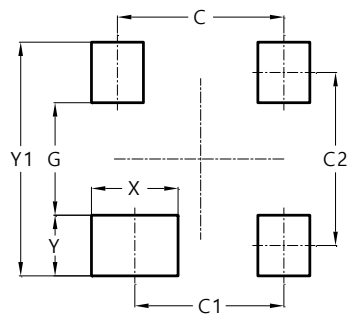


SOT143			
Dim	Min	Max	Typ
A1	0.37	0.51	0.40
A2	0.77	0.93	0.80
B	1.20	1.40	1.30
C	2.28	2.48	2.38
D	1.58	1.83	1.72
F	0.45	0.60	0.49
G	1.78	2.03	1.92
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.89	1.00	--
L	0.25	0.55	0.40
M	0.085	0.18	0.11
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT143



Dimensions	Value (in mm)
C	1.92
C1	1.72
C2	2.00
G	1.30
X	1.00
Y	0.70
Y1	2.70

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